Product data sheet

1. General description

The BGU8053 is, also known as the BTS1001H, a low noise high linearity amplifier for wireless infrastructure applications, equipped with fast shutdown to support TDD systems. The LNA has a high input and output return loss and is designed to operate between 2 GHz and 6 GHz. It is housed in a 2 mm \times 2 mm \times 0.75 mm 8-terminal plastic thin small outline package. The LNA is ESD protected on all terminals.

2. Features and benefits

- Low noise performance: NF = 0.56 dB
- High linearity performance: IP3_O = 36 dBm
- High input return loss > 12 dB
- High output return loss > 20 dB
- Unconditionally stable up to 20 GHz
- Programmable bias current (via resistor)
- Small 8-terminal leadless package 2 mm × 2 mm × 0.75 mm
- ESD protection on all terminals
- Moisture sensitivity level 1
- Fast shut down to support TDD systems
- 3 V to 5 V single supply

3. Applications

- Wireless infrastructure
- Low noise and high linearity applications
- LTE, W-CDMA, CDMA, GSM
- General-purpose wireless applications
- TDD or FDD systems
- Suitable for small cells



Low noise high linearity amplifier

4. Quick reference data

Table 1. Quick reference data

f = 2500 MHz; $V_{CC} = 5$ V; $T_{amb} = 25$ °C; input and output 50Ω ; $R \sim bias = 5.1$ k Ω ; unless otherwise specified. All RF parameters are measured in an application board as shown in <u>Figure 16</u> with components listed in <u>Table 9</u> optimized for f = 2500 MHz.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{CC}	supply current	on state		36	48	60	mA
		off state		-	2.8	-	mA
G _{ass}	associated gain	on state		17	18.5	20	dB
		off state		-	-23.5	-	dB
NF	noise figure		<u>[1]</u>	-	0.56	0.75	dB
P _{L(1dB)}	output power at 1 dB gain compression			-	18	-	dBm
IP3 _O	output third-order intercept point	2-tone; tone spacing = 1 MHz; P _i = -15 dBm per tone		32	36	-	dBm

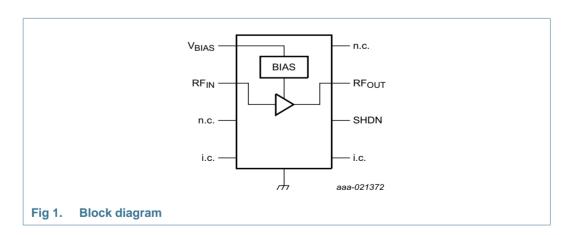
^[1] Connector and Printed-Circuit Board (PCB) losses have been de-embedded.

5. Ordering information

Table 2. Ordering information

Type number	Package						
	Name	Description	Version				
BGU8053	HWSON8	plastic thermal enhanced very very thin small outline package; no leads; 8 terminals; body $2\times2\times0.75~\text{mm}$	SOT1327-1				

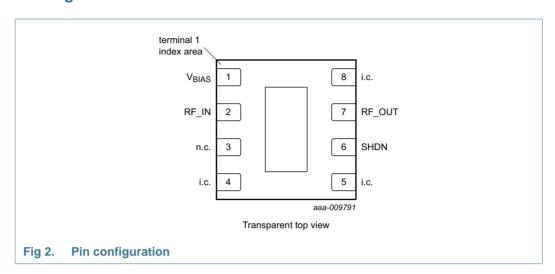
6. Block diagram



Low noise high linearity amplifier

7. Pinning information

7.1 Pinning



7.2 Pin description

Table 3. Pin description

Symbol	Pin	Description
V _{BIAS}	1	bias voltage
RF_IN	2	RF input
n.c.	3	not connected
i.c.	4, 5, 8	internally connected. Can be grounded or left open in the application
SHDN	6	shutdown
RF_OUT	7	RF output
GND	exposed die pad	ground

Low noise high linearity amplifier

8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-	6	V
V _{ctrl(sd)}	shutdown control voltage		-	3	V
I _{CC}	supply current		-	85	mA
P _{i(RF)CW}	continuous waveform RF input power		-	20	dBm
T _{stg}	storage temperature		-40	+150	°C
Tj	junction temperature		-	150	°C
Р	power dissipation	$T_{case} \le 125 ^{\circ}C$	-	510	mW
V _{ESD}	electrostatic discharge voltage	Human Body Model (HBM) According to ANSI/ESDA/JEDEC standard JS-001-2010	-	0.9	kV
		Charged Device Model (CDM); According to JEDEC standard 22-C101B	-	2	kV

^[1] Case is ground solder pad.

9. Recommended operating conditions

Table 5. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		4.75	5	5.25	V
Z_0	characteristic impedance		-	50	-	Ω
T _{case}	case temperature		-40	-	+85	°C

10. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
$R_{\text{th(j-case)}}$	thermal resistance from junction to case	[1][2]	50	K/W

^[1] Case is ground solder pad.

^[2] Thermal resistance measured using infrared measurement technique, device mounted on application board and placed in still air.

Low noise high linearity amplifier

11. Characteristics

Table 7. Characteristics

f = 1900 MHz; V_{CC} = 5 V; T_{amb} = 25 °C; input and output 50 Ω ; R_{bias} = 5.1 $k\Omega$; unless otherwise specified. All RF parameters are measured in an application board as shown in <u>Figure 16</u> with components listed in <u>Table 9</u> optimized for f = 1900 MHz.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{CC}	supply current	on state	36	48	60	mA
		off state	-	2.8	-	mA
G _{ass}	associated gain	on state	17	18.5	20	dB
		off state	-	-23	-	dB
NF	noise figure	[1	-	0.50	0.70	dB
P _{L(1dB)}	output power at 1 dB gain compression		-	18	-	dBm
IP3 _O	output third-order intercept point	2-tone; tone spacing = 1 MHz; $P_i = -15$ dBm per tone	32	36	-	dBm
		2-tone; tone spacing = 1 MHz; $P_i = -15$ dBm per tone	30	34	-	dBm
RLin	input return loss	on state	-	14.5	-	dB
		off state	-	8.4	-	dB
RL _{out}	output return loss		-	23	-	dB
ISL	isolation		-	23	-	dB
t _{s(pon)}	power-on settling time	$P_i = -20$ dBm; SHDN (pin 6) from HIGH to LOW	-	1.4	-	μS
t _{s(poff)}	power-off settling time	$P_i = -20$ dBm; SHDN (pin 6) from LOW to HIGH	-	0.4	-	μS
K	Rollett stability factor	both on state and off state up to f = 20 GHz	1	-	-	
R _{pd(SHDN)}	pull-down resistance on pin SHDN		-	20	-	kΩ

^[1] Connector and Printed-Circuit Board (PCB) losses have been de-embedded.

Table 8. Shutdown control

 $V_{CC} = 5 \text{ V; } T_{amb} = 25 \,^{\circ}\text{C.}$

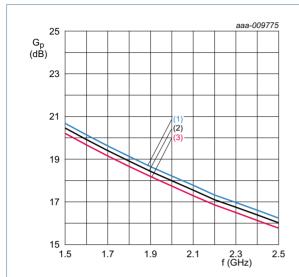
State	V _{ctrl(sd)} [1]	Unit
on state	≤ 0.6	V
off state	≥ 1.2	V

[1] Voltage on pin 6 (SHDN).

^[2] For TDD systems where fast switching is required, the value of C1 and C2 should be changed to 100 pF.

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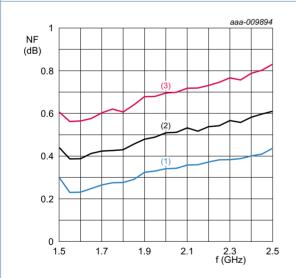
11.1 Graphics



$$V_{CC} = 5 \text{ V}; I_{CC} = 48 \text{ mA}.$$

- (1) $T_{amb} = -40 \, ^{\circ}C$
- (2) $T_{amb} = +25 \, ^{\circ}C$
- (3) $T_{amb} = +85 \, ^{\circ}C$

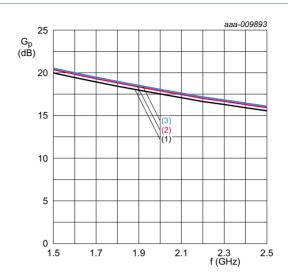
Fig 3. Power gain as a function of frequency; typical values



$$V_{CC} = 5 \text{ V;} I_{CC} = 48 \text{ mA.}$$

- (1) $T_{amb} = -40 \, ^{\circ}C$
- (2) $T_{amb} = +25 \, ^{\circ}C$
- (3) $T_{amb} = +85 \, ^{\circ}C$

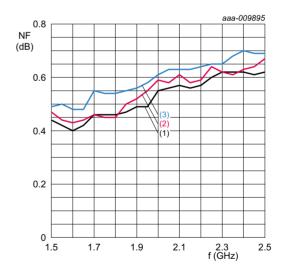
Fig 5. Noise figure as a function of frequency; typical values



$$V_{CC} = 5 \text{ V}; T_{amb} = 25 ^{\circ}\text{C}.$$

- (1) $I_{CC} = 30 \text{ mA}$
- (2) $I_{CC} = 45 \text{ mA}$
- (3) $I_{CC} = 60 \text{ mA}$

Fig 4. Power gain as a function of frequency; typical values

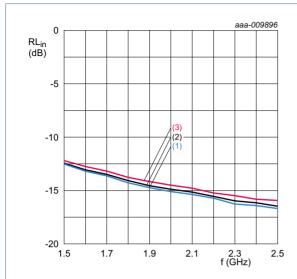


$$V_{CC} = 5 \text{ V}; T_{amb} = 25 \,^{\circ}\text{C}.$$

- (1) $I_{CC} = 30 \text{ mA}$
- (2) $I_{CC} = 45 \text{ mA}$
- (3) $I_{CC} = 60 \text{ mA}$

Fig 6. Noise figure as a function of frequency; typical values

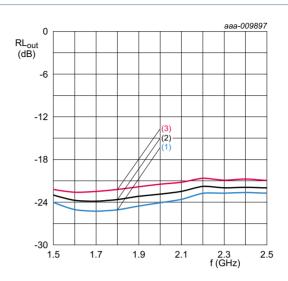
Low noise high linearity amplifier



$$V_{CC} = 5 \text{ V}; I_{CC} = 48 \text{ mA}.$$

- (1) $T_{amb} = -40 \, ^{\circ}C$
- (2) $T_{amb} = +25 \, ^{\circ}C$
- (3) $T_{amb} = +85 \, ^{\circ}C$

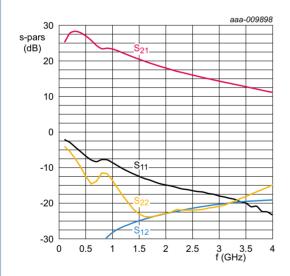
Fig 7. Input return loss as a function of frequency; typical values



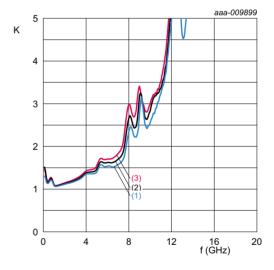
$$V_{CC} = 5 \text{ V}; I_{CC} = 48 \text{ mA}.$$

- (1) $T_{amb} = -40 \, ^{\circ}C$
- (2) $T_{amb} = +25 \, ^{\circ}C$
- (3) $T_{amb} = +85 \, ^{\circ}C$

Fig 8. Output return loss as a function of frequency; typical values



 $V_{CC} = 5 \text{ V}; T_{amb} = 25 \,^{\circ}\text{C}; I_{CC} = 48 \text{ mA}.$



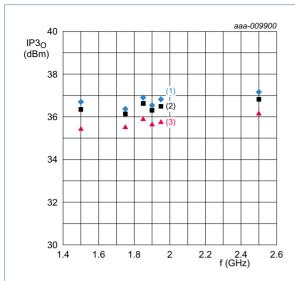
 V_{CC} = 5 V; I_{CC} = 48 mA.

- (1) $T_{amb} = -40 \, ^{\circ}C$
- (2) $T_{amb} = +25 \, ^{\circ}C$
- (3) $T_{amb} = +85 \, ^{\circ}C$

Fig 10. Rollett stability factor as a function of frequency; typical values

Fig 9. Wideband S-parameters as function of frequency; typical values

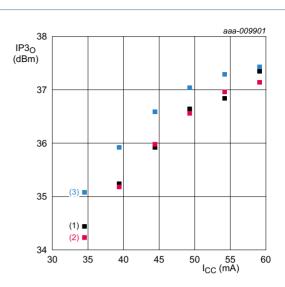
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 $V_{CC} = 5 \text{ V}$; $P_i = -15 \text{ dBm per tone}$; $I_{CC} = 48 \text{ mA}$.

- (1) $T_{amb} = -40 \, ^{\circ}C$
- (2) $T_{amb} = +25 \, ^{\circ}C$
- (3) $T_{amb} = +85 \, ^{\circ}C$

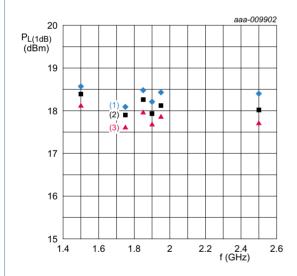
Fig 11. Output third-order intercept point as a function of frequency; typical values



 $V_{CC} = 5 \text{ V}$; $P_i = -15 \text{ dBm per tone}$; $T_{amb} = 25 \,^{\circ}\text{C}$.

- (1) f = 1500 MHz
- (2) f = 1900 MHz
- (3) f = 2500 MHz

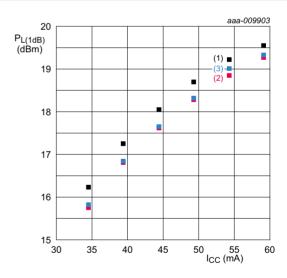
Fig 12. Output third-order intercept point as a function of supply current; typical values



 $V_{CC} = 5 \text{ V}; I_{CC} = 48 \text{ mA}.$

- (1) $T_{amb} = -40 \, ^{\circ}C$
- (2) $T_{amb} = +25 \, ^{\circ}C$
- (3) $T_{amb} = +85 \, ^{\circ}C$

Fig 13. Output power at 1 dB gain compression as a function of frequency; typical values

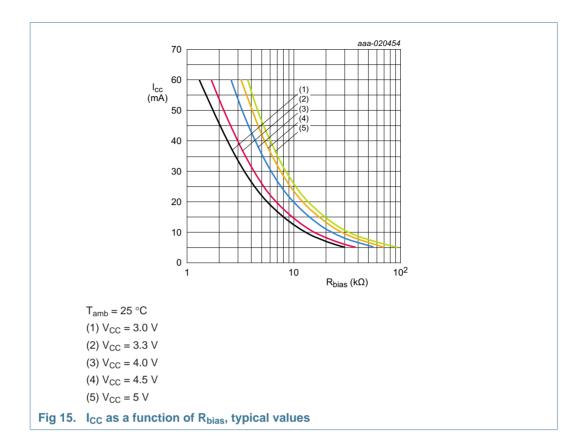


 $V_{CC} = 5 \text{ V}; T_{amb} = 25 ^{\circ}\text{C}.$

- (1) f = 1500 MHz
- (2) f = 1900 MHz
- (3) f = 2500 MHz

Fig 14. Output power at 1 dB gain compression as a function of supply current; typical values

Low noise high linearity amplifier



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12. Application information

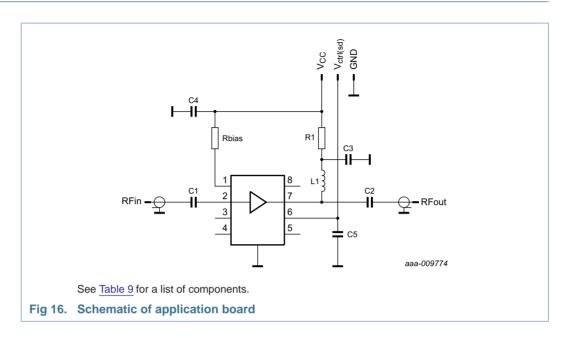


Table 9. List of components See Figure 16 for schematics.

Component	Description	Value	Remarks
C1, C2	capacitor	100 nF	
		100 pF	recommended for TDD systems
C3, C5	capacitor	10 pF	
C4	capacitor	10 nF	
L1	inductor	15 nH	
R1	resistor	10 Ω	
R _{bias}	resistor	5.1 kΩ	V _{CC} = 5 V
		2.3 kΩ	V _{CC} = 3.3 V

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Table 10. Typical performance BGU8053 application board $V_{CC} = 5 \text{ V}$

All RF parameters are measured at the application board as shown in <u>Figure 16</u>. With the components as listed in <u>Table 9</u> while optimized for: f = 2500 MHz, $V_{CC} = 5$ V, $I_{CC} = 48$ mA and $T_{amb} = 25$ °C.

Symbol	Parameter	Conditions	f (MHz)							
			2000	2300	2500	2700	3000	3400	3500	3800
G	gain		20.2	19.0	18.3	17.6	16.6	15.4	15.1	14.2
RL _{in}	input return loss		11.0	11.8	12.3	12.6	13.3	14.0	13.8	14.9
RL _{out}	output return loss		30.1	28.9	28.7	27.1	23.4	18.2	17.3	14.7
P _{L(1dB)}	output power at 1 dB gain compression		18.5	18.6	18.2	18.1	18.2	16.9	16.2	14.9
IP3 _O	output third-order	[1]	35.5	35.4	35.4	35.2	34.3	33.4	33.3	32.5
	intercept point	[1][2]	34.8	36.3	36.3	36.4	35.6	32.5	33.1	31.9
NF	noise figure	[3]	0.52	0.59	0.63	0.68	0.67	0.76	0.78	0.87

^{[1] 2-}Tone; tone spacing = 1 MHz, P_0 = 5 dBm per tone.

Table 11. Typical performance BGU8053 application board $V_{CC} = 3.3 \text{ V}$

All RF parameters measured at application board shown in Figure 16. With the components as listed in Table 9 while optimized for 2500 MHz, $V_{CC} = 3.3 \text{ V}$, $I_{CC} = 48 \text{ mA}$, $T_{amb} = 25^{\circ} \text{C}$

Symbol Parameter		Conditions		f (MHz)							
			2000	2300	2500	2700	3000	3400	3500	3800	
G	gain		20.1	18.9	18.1	17.4	16.4	15.3	15.0	14.1	
RLin	input return loss		11.3	12.1	12.4	14.1	13.6	13.7	15.0	15.3	
RL _{out}	output return loss		32.9	29.5	27.8	27.5	23.4	18.6	17.7	15.4	
P _{L(1dB)}	output power at 1 dB gain compression		16.0	15.4	14.9	15.1	14.5	14.0	13.9	12.7	
IP3 _O	output third-order	[1]	29.2	28.8	29.0	28.1	27.1	26.0	26.3	23.4	
	intercept point	[1][2]	30.2	29.9	29.0	29.1	28.4	26.2	25.8	25.9	
NF	noise figure	[3]	0.55	0.58	0.60	0.63	0.69	0.78	0.80	0.89	

^{[1] 2-}Tone; tone spacing = 1 MHz, P_0 = 5 dBm per tone.

^[2] For applications where fast switching is required, the value of C1 and C2 should be changed to 100 pF.

^[3] Connector and board losses not de-embedded.

^[2] For applications where fast switching is required, the value of C1 and C2 should be changed to 100 pF.

^[3] Connector and board losses not de-embedded.

Low noise high linearity amplifier

13. Package outline

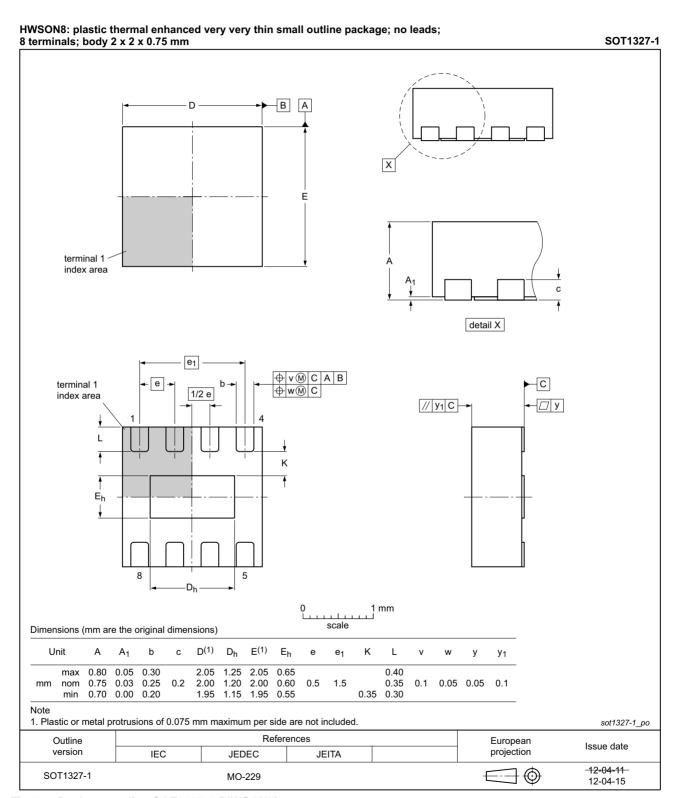


Fig 17. Package outline SOT1327-1 (HWSON8)

Low noise high linearity amplifier

14. Abbreviations

Table 12. Abbreviations

Acronym	Description
CDMA	Code Division Multiple Access
ESD	ElectroStatic Discharge
FDD	Frequency-Division Duplexing
GSM	Global System for Mobile Communication
LNA	Low Noise Amplifier
LTE	Long-Term Evolution
RF	Radio Frequency
TDD	Time-Division Duplexing
W-CDMA	Wideband Code Division Multiple Access

15. Revision history

Table 13. Revision history

Release date	Data sheet status	Change notice	Supersedes
20170120	Product data sheet	-	BGU8053 v.3
Section 1 on page 1: added BTS1001H according to our new naming convention			
20160418	Product data sheet	-	BGU8053 v.2
3 V to 5 V single supply added to <u>Section 2 "Features and benefits"</u>			
Figure 1 "Block diagram" on page 2 added			
An additional curve added to Figure 14 on page 8			
 Added remark to R_{bias} in <u>Table 9 on page 10</u> 			
• Table 11 on page 11 added			
20131230	Product data sheet	-	BGU8053 v.1
 Table 4 on page 3: The maximum value for V_{ctrl(sd)} has been corrected to 3 V. 			
20131127	Product data sheet	-	-
	20170120 Section 1 on page 20160418 3 V to 5 V single: Figure 1 "Block di An additional curv Added remark to Table 11 on page 20131230 Table 4 on page 3	Product data sheet Section 1 on page 1: added BTS1001H according 20160418 Product data sheet 3 V to 5 V single supply added to Section 2 "Feature Figure 1 "Block diagram" on page 2 added An additional curve added to Figure 14 on page 8 Added remark to R _{bias} in Table 9 on page 10 Table 11 on page 11 added 20131230 Product data sheet Table 4 on page 3: The maximum value for V _{ctrl(sd)}	Product data sheet Section 1 on page 1: added BTS1001H according to our new naming conversed 20160418 Product data sheet 3 V to 5 V single supply added to Section 2 "Features and benefits" Figure 1 "Block diagram" on page 2 added An additional curve added to Figure 14 on page 8 Added remark to R _{bias} in Table 9 on page 10 Table 11 on page 11 added 20131230 Product data sheet Table 4 on page 3: The maximum value for V _{ctrl(sd)} has been corrected to 3

Low noise high linearity amplifier

16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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BGU8053

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Low noise high linearity amplifier

18. Contents

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